

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S20 1	3576	((438/14) or (438/110) or (438/125) or (438/456)).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/12/20 14:23
S20 2	16075	align\$6 with drop\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/12 17:52
S20 3	89130	surface adj tension	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/12 17:54
S20 4	2243680	chip wafer dice die package ic	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/12 17:52
S20 5	3	S202 with S203 with S204	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/12 17:52
S20 6	11	S202 same S203 same S204	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/12 17:54
S20 7	8	S206 not S205	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/12 17:52
S20 8	6	S207 and (@ad < "20030705")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/12 17:54
S20 9	94910	surface near2 tension	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/12 17:54

S21 0	81	S202 same S203 same S209	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/12 17:58
S21 1	67	S210 and (@ad < "20030705")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/12 17:59
S21 2	61	S211 not S208	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/12 17:54
S21 3	2824	align\$6 same S203 same S209	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/12 17:58
S21 4	626	align\$6 with S209 same S204	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/12 17:59
S21 5	396	align\$6 with S209 with S204	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/12 17:59
S21 6	341	S215 and (@ad < "20030705")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/12 17:59